



High-end Power Semiconductor Manufacturer

## KP2000A 400V-800V Phase Control Thyristor

- High power cycling capability
- Low on-state and switching losses
- Designed for traction and industrial applications



Mean on-state current	$I_{TAV}$	2000 A			
Repetitive peak off-state voltage	$V_{DRM}$	400 – 800 V			
Repetitive peak reverse voltage	$V_{RRM}$				
Turn-off time	$t_q$	160 $\mu$ s			
$V_{DRM}, V_{RRM}, V$	400	500	600	700	800
Voltage code	4	5	6	7	8
$T_j, ^\circ\text{C}$	-60 – 140				

### MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
$I_{TAV}$	Mean on-state current	A	2000	$T_c=85^\circ\text{C}$ , Double side cooled 180° half-sine wave; 50 Hz	
$I_{TRMS}$	RMS on-state current	A	3140	$T_c=85^\circ\text{C}$ , Double side cooled 180° half-sine wave; 50 Hz	
$I_{TSM}$	Surge on-state current	kA	45.0 52.0	$T_j=T_{j\max}$ $T_j=25^\circ\text{C}$	180° half-sine wave; 50 Hz ( $t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			48.0 55.0		$T_j=T_{j\max}$ $T_j=25^\circ\text{C}$
$I^2t$	Safety factor	$\text{A}^2\text{s}\cdot 10^3$	10125 13520	$T_j=T_{j\max}$ $T_j=25^\circ\text{C}$	180° half-sine wave; 50 Hz ( $t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			9560 12550		$T_j=T_{j\max}$ $T_j=25^\circ\text{C}$
<b>BLOCKING</b>					
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	400–800	$T_{j\min} < T_j < T_{j\max}$ ; 180° half-sine wave; 50 Hz; Gate open	
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	500–900	$T_{j\min} < T_j < T_{j\max}$ ; 180° half-sine wave; 50 Hz; single pulse; Gate open	
$V_D, V_R$	Direct off-state and Direct reverse voltages	V	$0.75\cdot V_{DRM}$ $0.75\cdot V_{RRM}$	$T_j=T_{j\max}$ ; Gate open	

<b>TRIGGERING</b>				
$I_{FGM}$	Peak forward gate current	A	8	$T_j = T_{j\max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	4	$T_j = T_{j\max}$ for DC gate current
<b>SWITCHING</b>				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/ $\mu$ s	400	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; $I_{TM} = 2 I_{TAV}$ ; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
<b>THERMAL</b>				
$T_{stg}$	Storage temperature	$^{\circ}$ C	-60 -140	
$T_j$	Operating junction temperature	$^{\circ}$ C	-60 -140	
<b>MECHANICAL</b>				
F	Mounting force	kN	24.0 -28.0	
a	Acceleration	m/s <sup>2</sup>	50 100	Device unclamped Device clamped

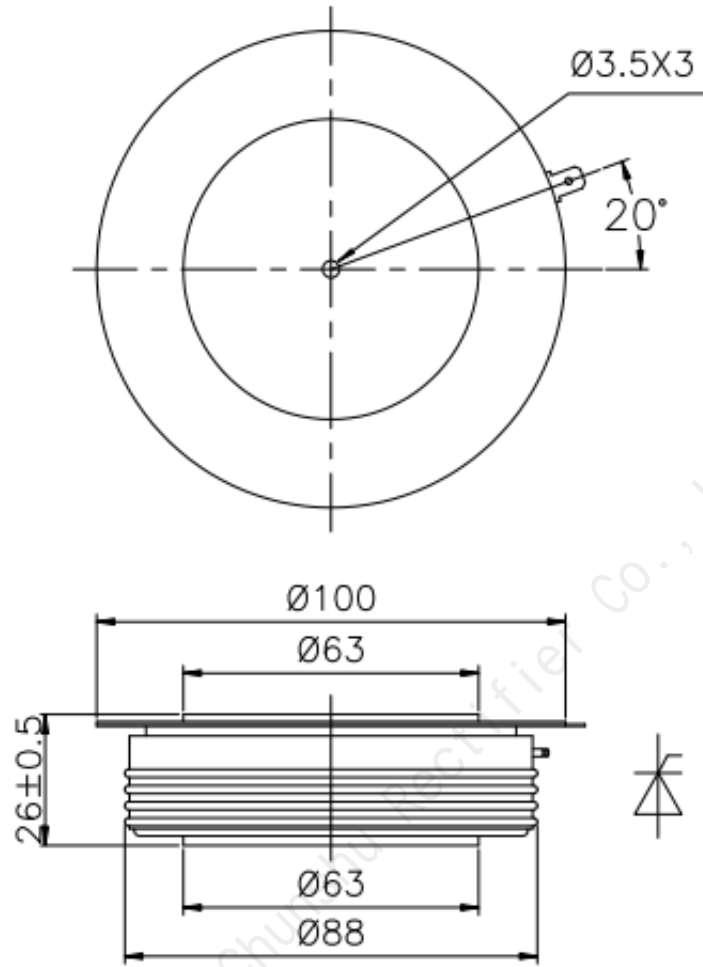
## CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
<b>ON-STATE</b>					
$V_{TM}$	Peak on-state voltage, max	V	1.65	$T_j = 25^{\circ}$ C; $I_{TM} = 6280$ A	
$V_{T(TO)}$	On-state threshold voltage, max	V	0.85	$T_j = T_{j\max}$ ;	
$r_T$	On-state slope resistance, max	m $\Omega$	0.140	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
$I_L$	Latching current, max	mA	1500	$T_j = 25^{\circ}$ C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s	
$I_H$	Holding current, max	mA	300	$T_j = 25^{\circ}$ C; $V_D = 12$ V; Gate open	
<b>BLOCKING</b>					
$I_{DRM}, I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	150	$T_j = T_{j\max}$ ; $V_D = V_{DRM}$ ; $V_R = V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	1000	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; Gate open	
<b>TRIGGERING</b>					
$V_{GT}$	Gate trigger direct voltage, max	V	3.00 2.00	$T_j = 25^{\circ}$ C $T_j = T_{j\max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current
$I_{GT}$	Gate trigger direct current, max	mA	300 200	$T_j = 25^{\circ}$ C $T_j = T_{j\max}$	
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.25	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ;	
$I_{GD}$	Gate non-trigger direct current, min	mA	10.00	Direct gate current	
<b>SWITCHING</b>					
$t_{gd}$	Delay time	$\mu$ s	1.60	$T_j = 25^{\circ}$ C; $V_D = 0.4 \cdot V_{DRM}$ ; $I_{TM} = I_{TAV}$ ; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s	
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	160	$dv_D/dt = 50$ V/ $\mu$ s; $T_j = T_{j\max}$ ; $I_{TM} = I_{TAV}$ ; $di_R/dt = -10$ A/ $\mu$ s; $V_R = 100$ V; $V_D = 0.67 \cdot V_{DRM}$	
$Q_{rr}$	Total recovered charge, max	$\mu$ C	1250	$T_j = T_{j\max}$ ; $I_{TM} = 2000$ A;	
$t_{rr}$	Reverse recovery time, max	$\mu$ s	18.0	$di_R/dt = -10$ A/ $\mu$ s ;	
$I_{rrM}$	Peak reverse recovery current, max	A	140	$V_R = 100$ V	

<b>THERMAL</b>					
$R_{thjc}$	Thermal resistance, junction to case, max	°C/W	0.0180	Direct current	Double side cooled
$R_{thjc-A}$			0.0396		Anode side cooled
$R_{thjc-K}$			0.0324		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	°C/W	0.0040	Direct current	
<b>MECHANICAL</b>					
w	Weight, typ	g	330		
$D_s$	Surface creepage distance	mm (inch)	7.51 (0.295)		
$D_a$	Air strike distance	mm (inch)	5.60 (0.220)		

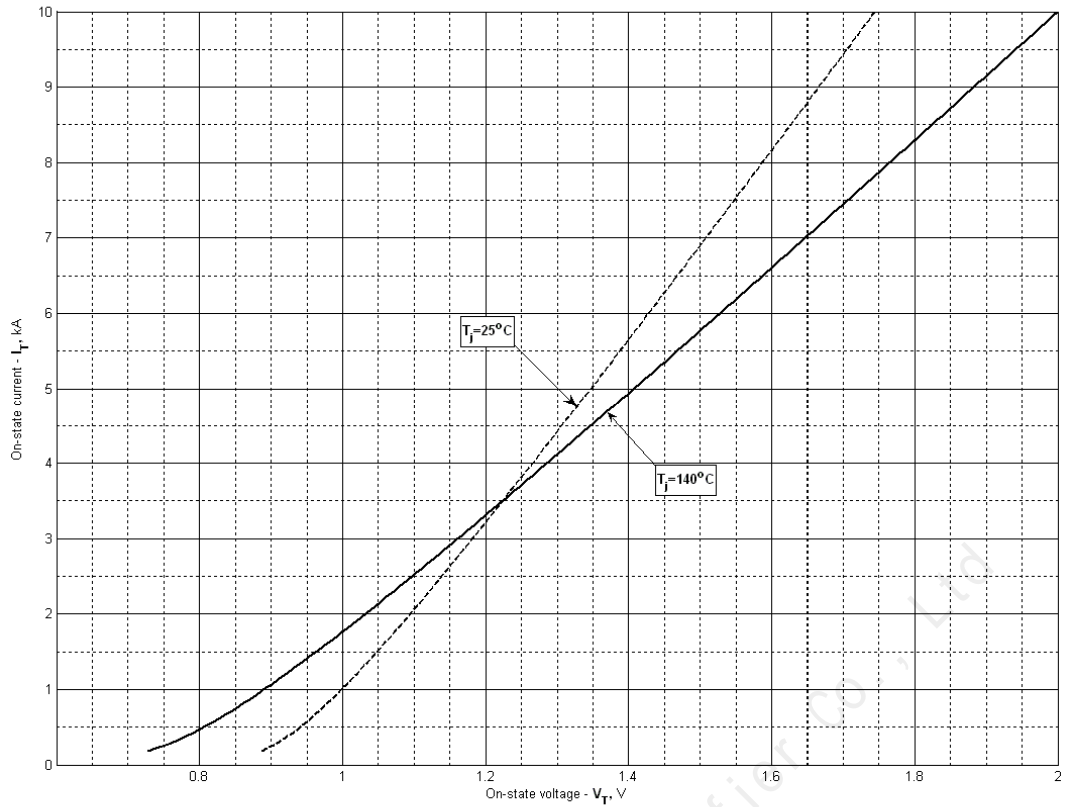
Beijing Xinchuang Chunshu Rectifier Co., Ltd

OVERALL DIMENSIONS



KT70

All dimensions in millimeters



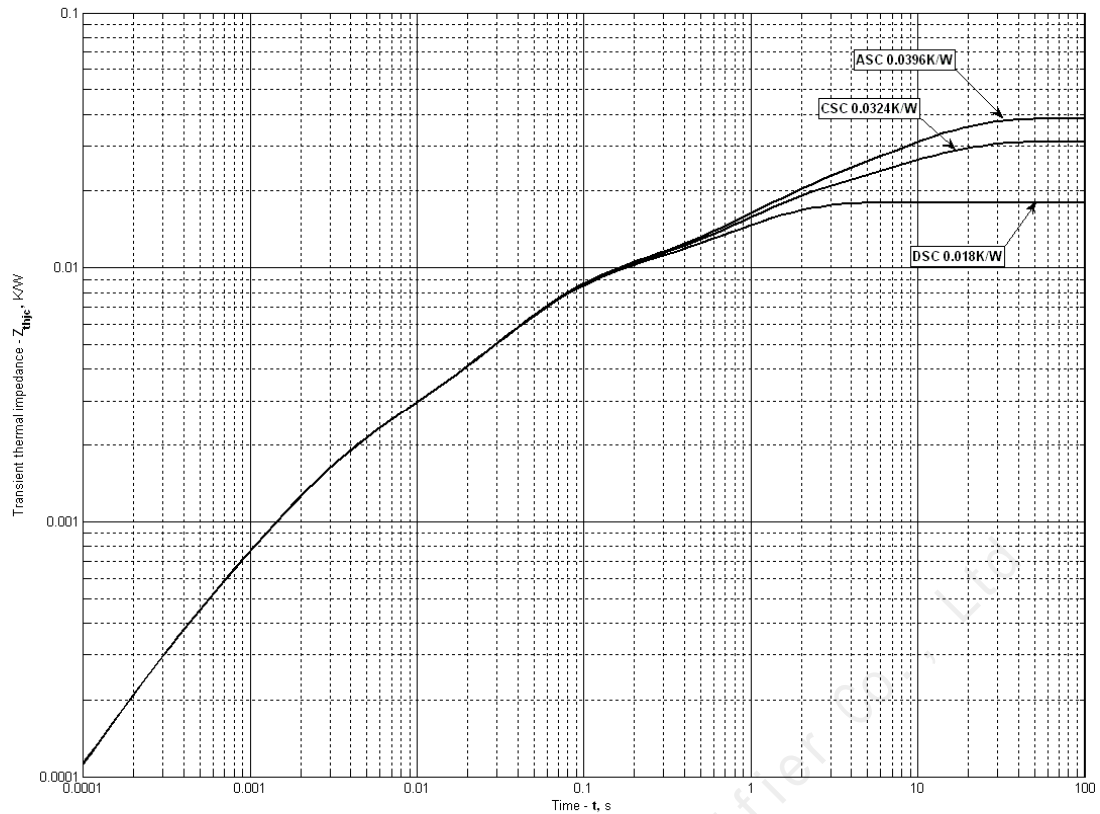
**Fig 1 – On-state characteristics of Limit device**

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j\text{max}}$
<b>A</b>	0.773580	0.570257
<b>B</b>	0.043627	0.068904
<b>C</b>	-0.211220	-0.292731
<b>D</b>	0.328431	0.455175

**On-state characteristic model (see Fig. 1)**



**Fig 2 – Transient thermal impedance**

Analytical function for Transient thermal impedance junction to case  $Z_{thjc}$  for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left( 1 - e^{-\frac{t}{\tau_i}} \right)$$

Where  $i = 1$  to  $n$ ,  $n$  is the number of terms in the series.

$t$  = Duration of heating pulse in seconds.

$Z_{thjc}$  = Thermal resistance at time  $t$ .

$R_i$  = Amplitude of  $p_{th}$  term.

$\tau_i$  = Time constant of  $r_{th}$  term.

DC Double side cooled

$i$	1	2	3	4	5	6
$R_i$ K/W	0.009241	0.006037	0.001231	0.001054	0.0003396	0.00009575
$\tau_{ij}$ s	0.9673	0.04967	0.002733	0.07734	0.001638	0.0002248

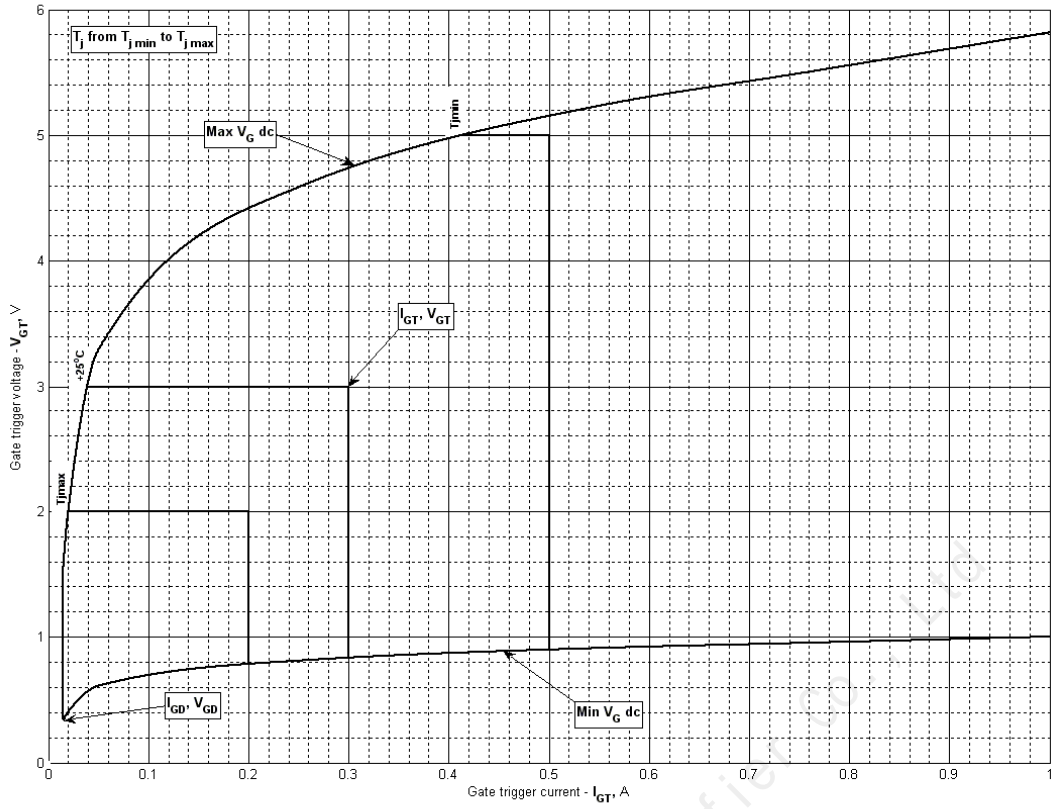
DC Cathode side cooled

$i$	1	2	3	4	5	6
$R_i$ K/W	0.01318	0.009281	0.006055	0.001018	0.001535	0.0001182
$\tau_{ij}$ s	9.745	1.028	0.05591	0.03732	0.002468	0.0002687

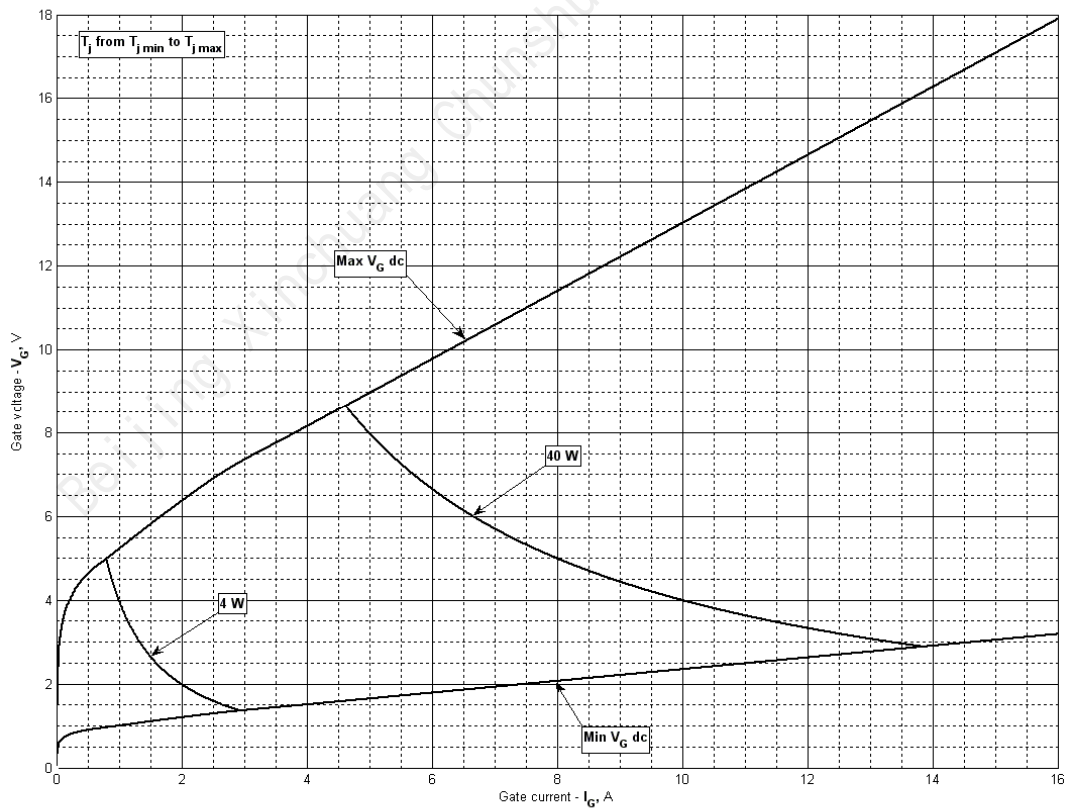
DC Anode side cooled

$i$	1	2	3	4	5	6
$R_i$ K/W	0.02041	0.009325	0.006949	0.0001252	0.001516	0.0001119
$\tau_{ij}$ s	9.752	1.065	0.05344	0.01407	0.002421	0.0002554

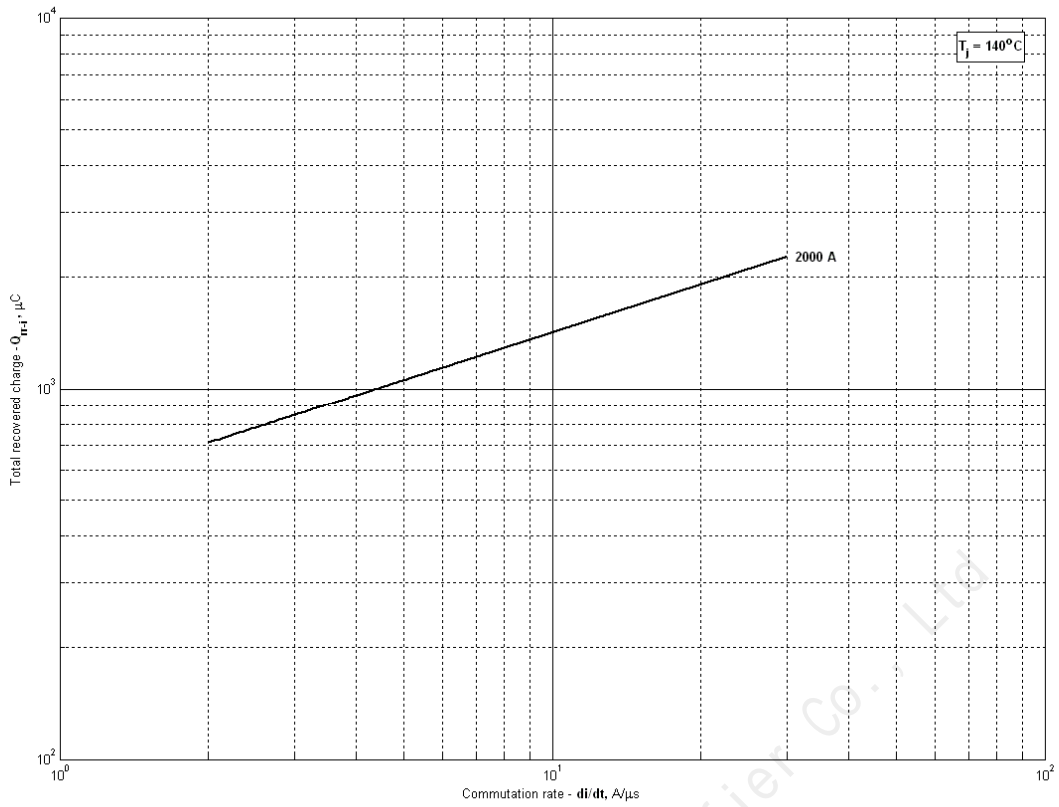
**Transient thermal impedance junction to case  $Z_{thjc}$  model (see Fig. 2)**



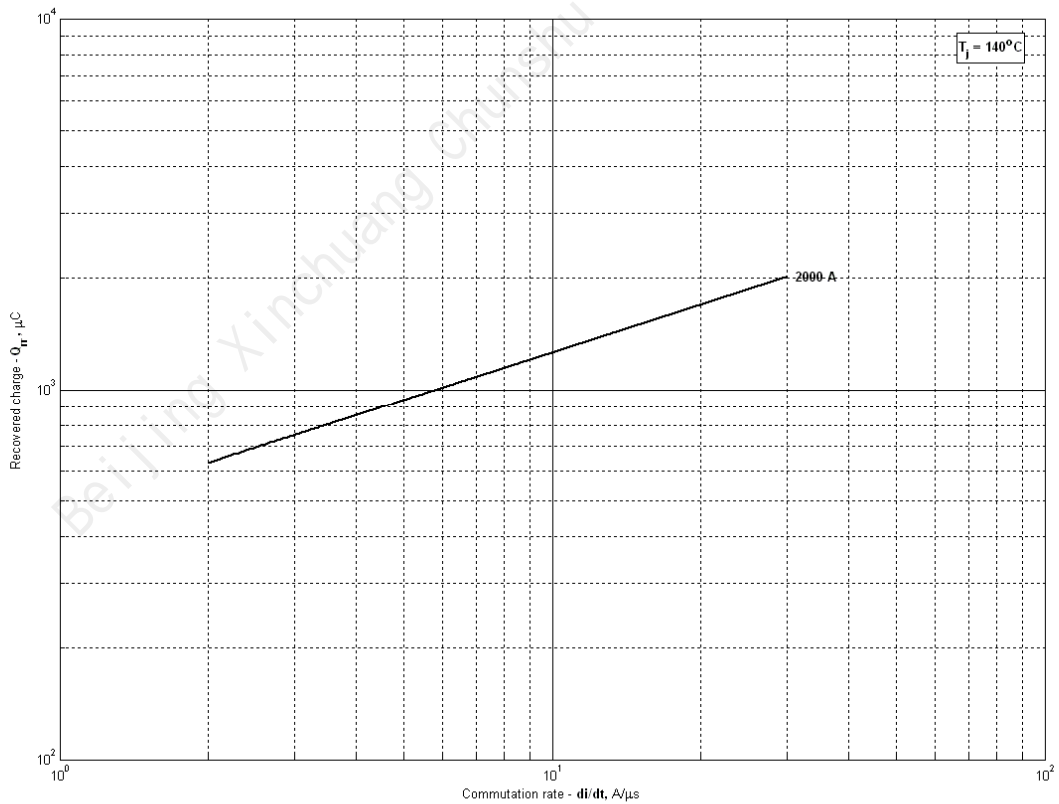
**Fig 3 – Gate characteristics – Trigger limits**



**Fig 4 - Gate characteristics –Power curves**

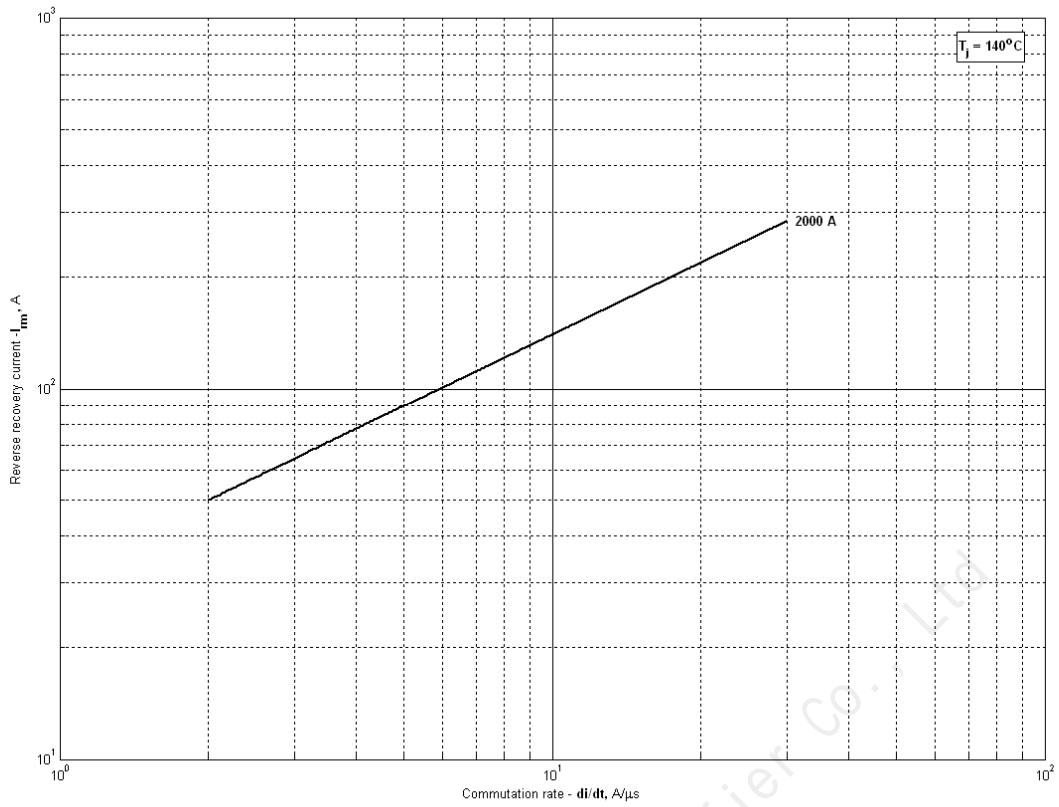


**Fig 5 – Total recovered charge,  $Q_{rr-i}$  (integral)**

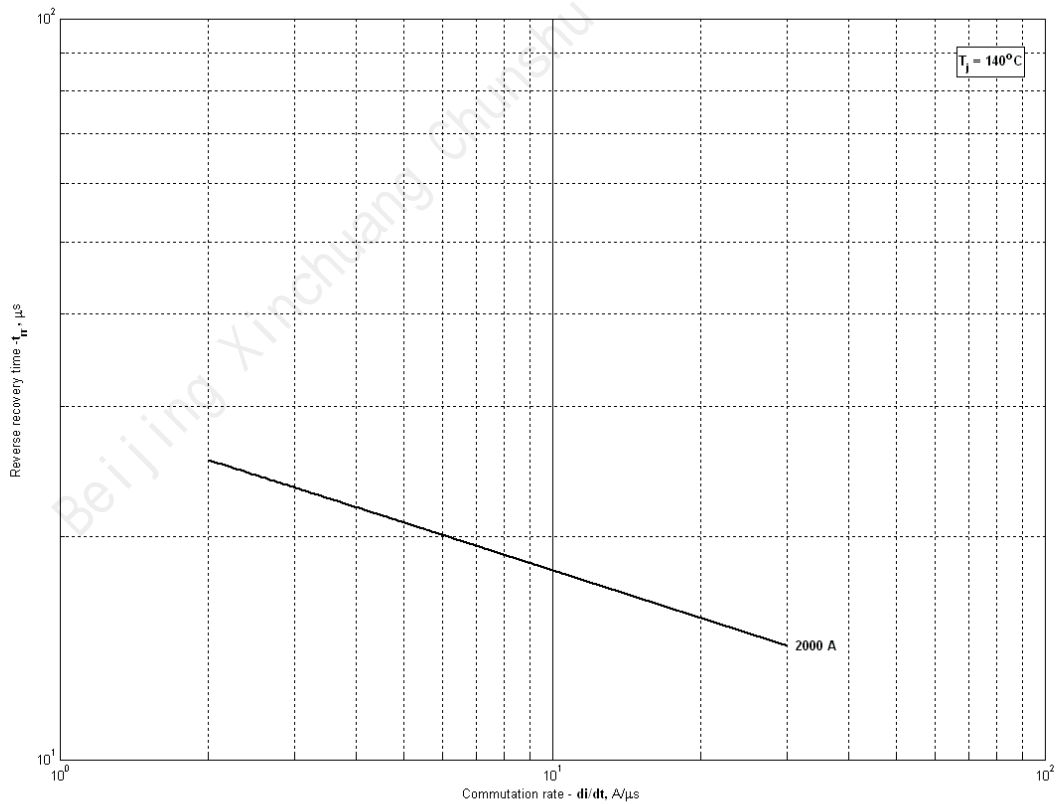


**Fig 6 - Recovered charge,  $Q_{rr}$  (linear)**

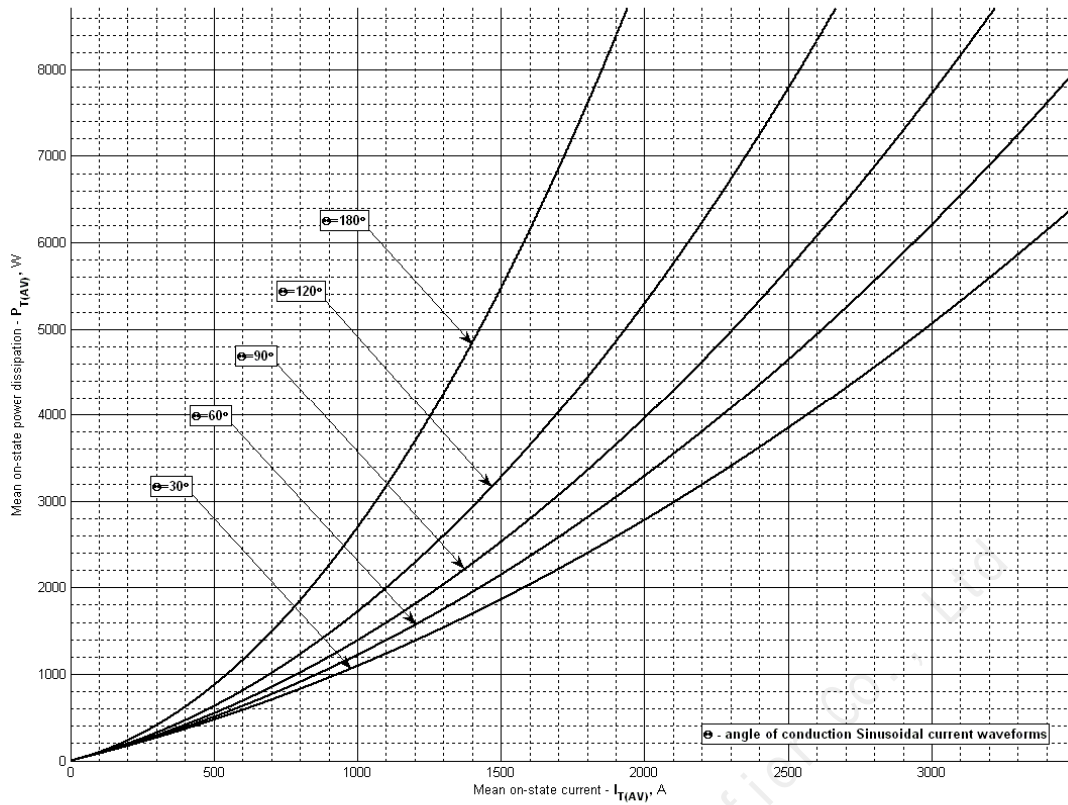




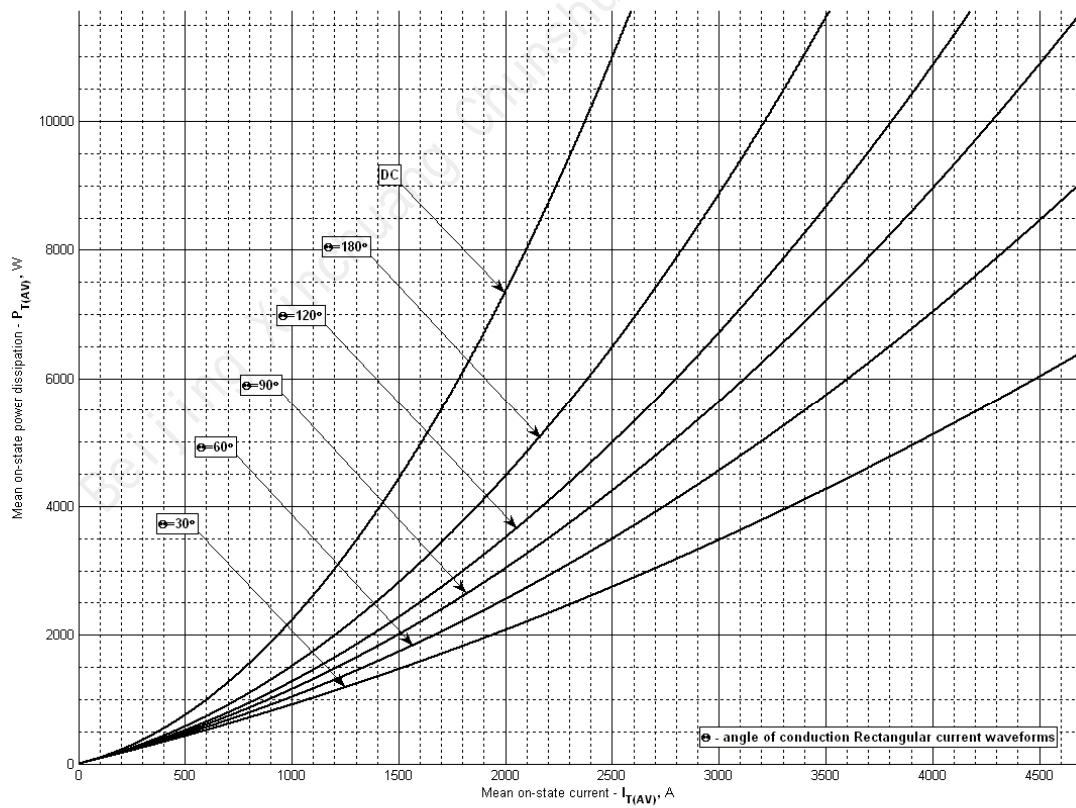
**Fig 7 – Peak reverse recovery current,  $I_{rm}$**



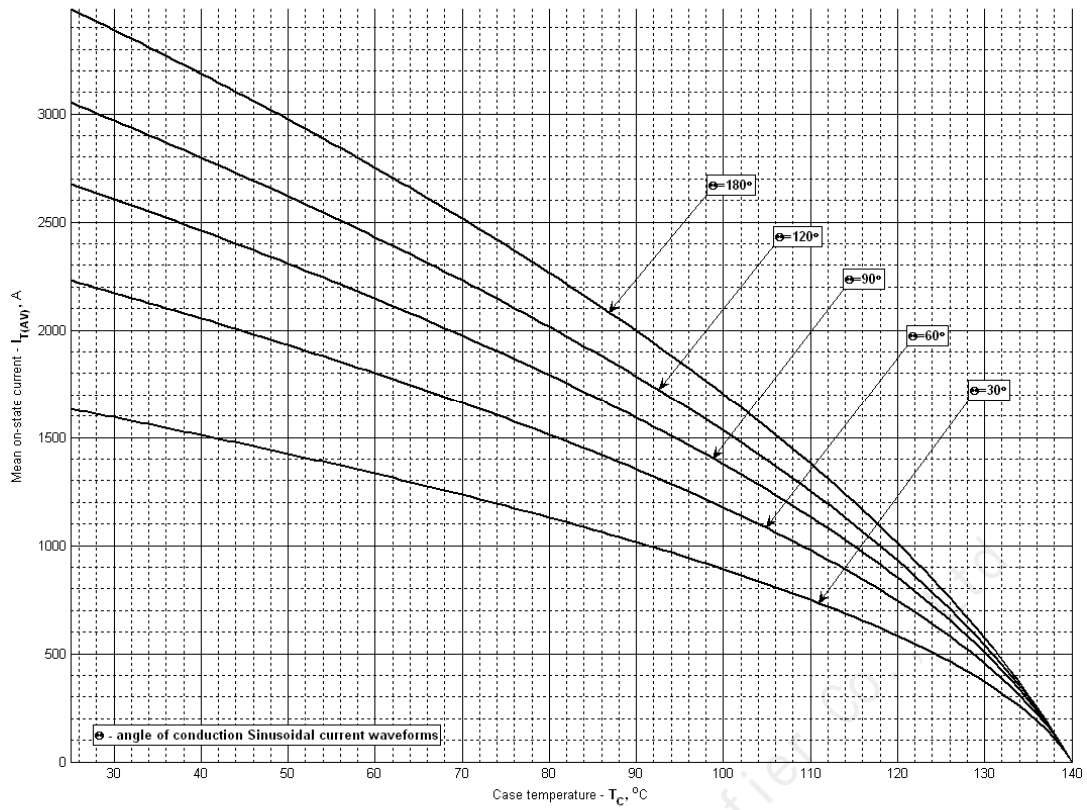
**Fig 8 – Maximum recovery time,  $t_{rr}$  (linear)**



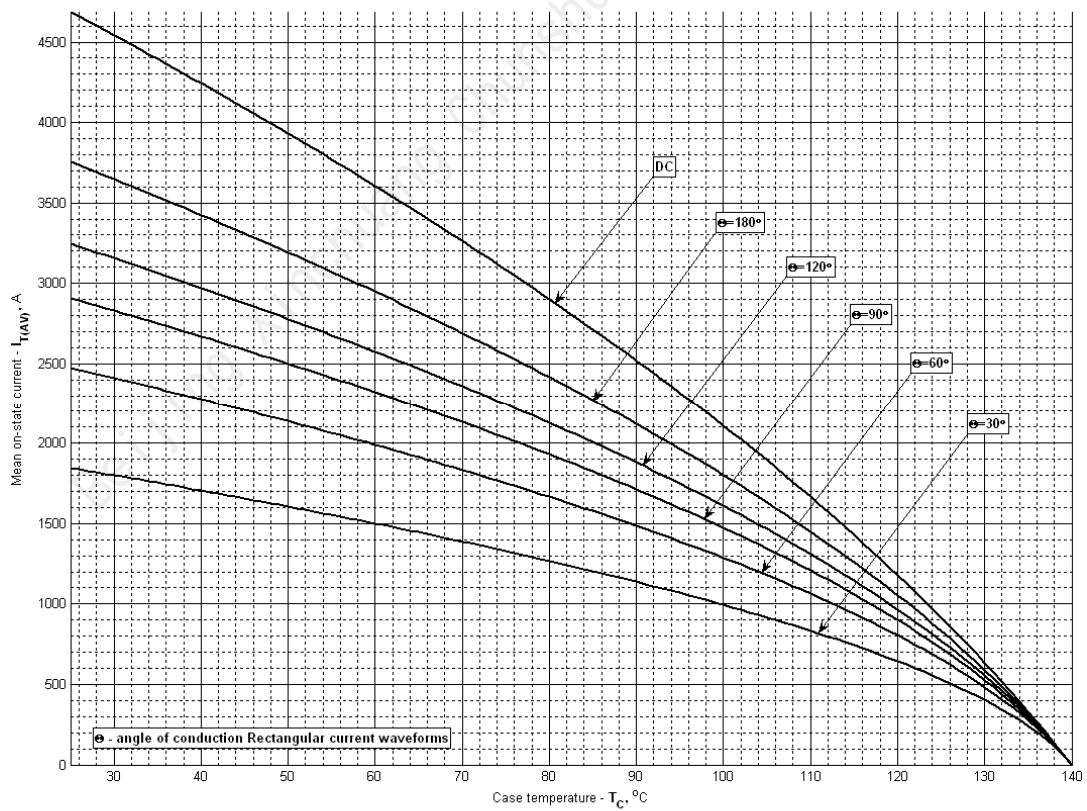
**Fig 9 – On-state power loss (sinusoidal current waveforms)**



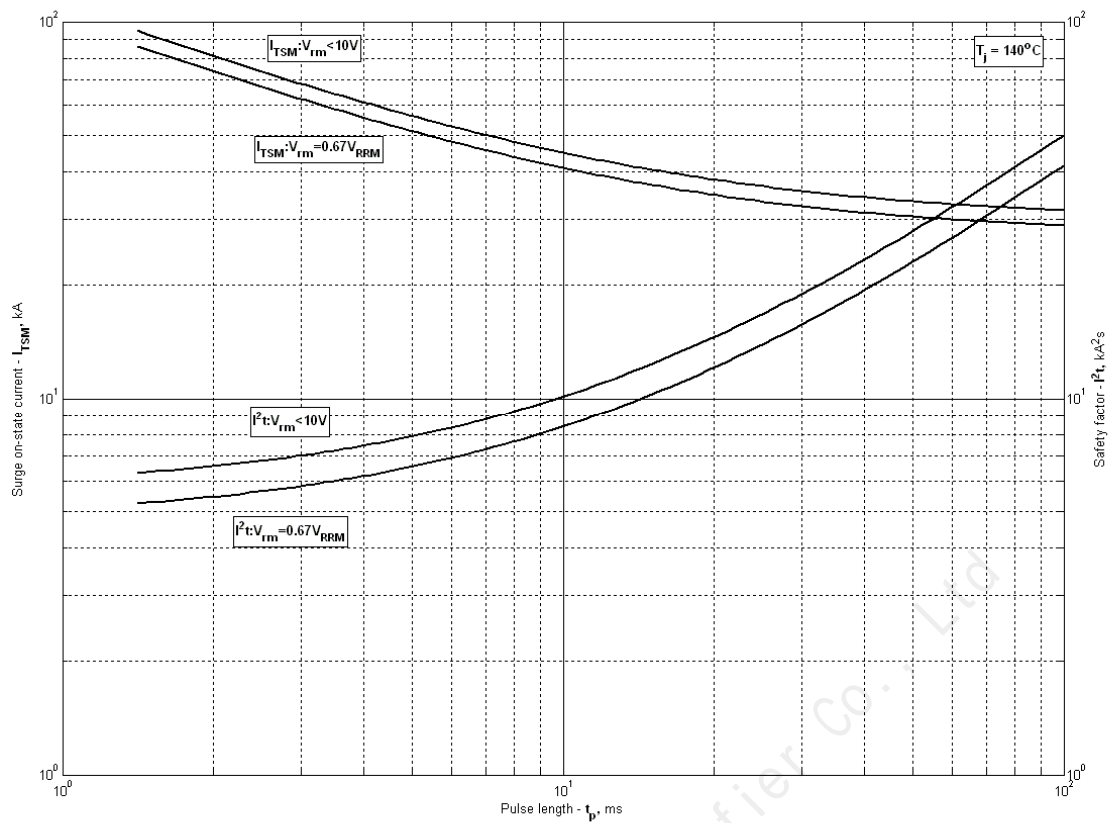
**Fig 10 – On-state power loss (rectangular current waveforms)**



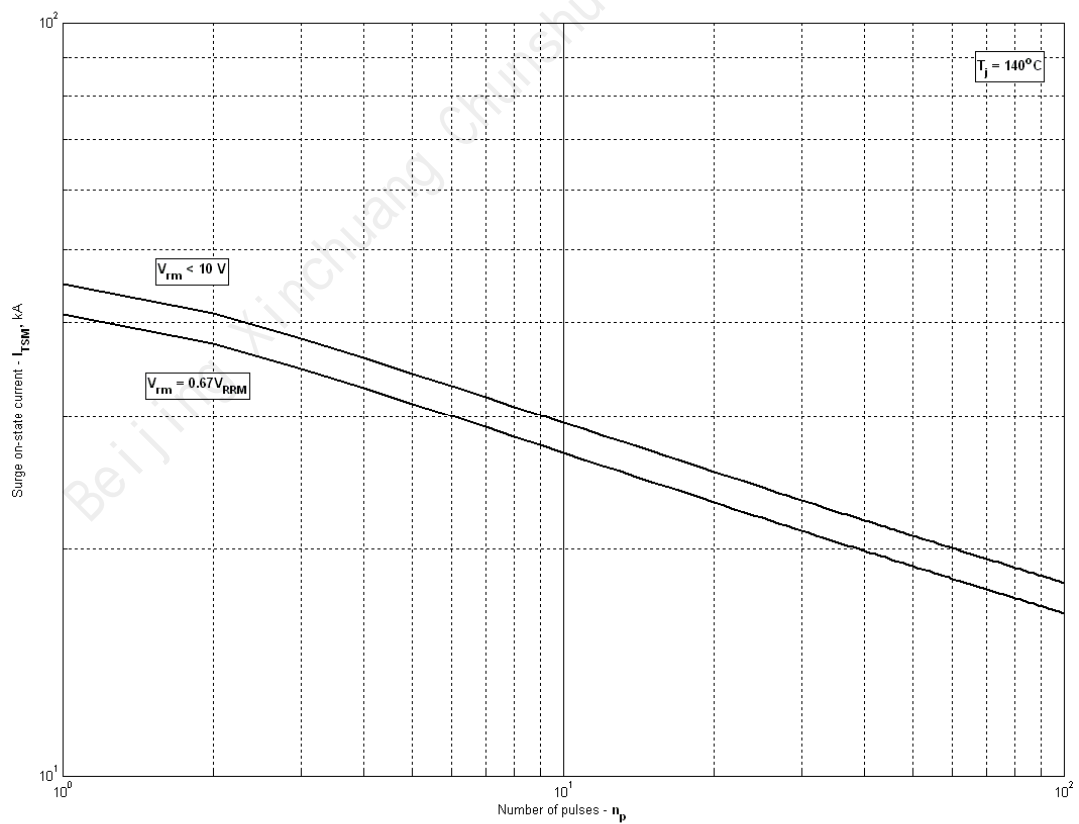
**Fig 11 – Maximum case temperature DSC (sinusoidal current waveforms)**



**Fig 12 – Maximum case temperature DSC (rectangular current waveforms)**



**Fig 13 – Maximum surge and  $I^2t$  ratings**



**Fig 14 – Maximum surge ratings**